

#### Is Now Part of



# ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



April 2012

# FSUSB20 — Low-Power, 1-Port, High-Speed USB (480Mbps) Switch

#### **Features**

-30dB Off Isolation: 250MHz

-30dB Non-adjacent Channel Crosstalk: 250MHz

■ On Resistance: 4.5Ω Typical (Ro<sub>N</sub>)

-3dB Bandwidth: >720MHz

■ Low-Power Consumption: 1µA Maximum

Control Input: LVTTL Compatible

Bi-Directional Operation

 USB High-Speed and Full-Speed Signaling Capability

# **Applications**

 Cell Phones, PDAs, Digital Cameras, Notebook Computers

## Description

FSUSB20 is a low-power, high-bandwidth switch specially designed for switching high-speed USB 2.0 signals in handset and consumer applications; such as cell phone, digital camera, and notebook with hubs or controllers of limited USB I/O. The wide bandwidth (>720MHz) allows signals to pass with minimum edge and phase distortion. Superior channel-to-channel crosstalk results in minimal interference. It is compatible with the high-speed USB 2.0 standard.

# **Ordering Information**

Part Number Operating Temperature Range		Package	Packing Method
FSUSB20L10X	-40 to +85°C	10-Lead MicroPak™, 1.6 x 2.1mm	Tape and Reel
FSUSB20BQX	-40 to +85°C	14-Terminal Depopulation Quad Very-Thin Flat Pack No Lead (DQFN), JEDEC MO-241, 2.5 X 3.0mm	Tube
FSUSB20MUX -40 to +85°C 10-Lead Molded Small Outl		10-Lead Molded Small Outline Package (MSOP), JEDEC MO-187, 3.0mm Wide	Tape and Reel

# **Connection Diagrams**

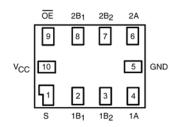


Figure 1. MicroPak™ (Top View)

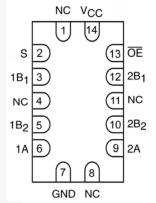


Figure 3. DQFN (Top Through View)

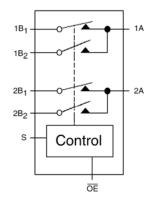


Figure 2. Analog Symbol

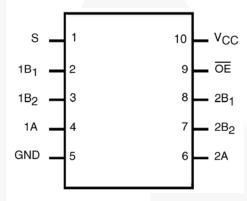


Figure 4. MSOP (Top Through View)

# **Pin Descriptions**

Pin # MicroPak™ / MSOP	croPak™ / MSOP Pin # DQFN Pin Names		Description
1	2	S	Select Input
2, 3, 7, 8	3, 5, 10, 12	1B <sub>1</sub> , 1B <sub>2</sub> , 2B <sub>2</sub> , 2B <sub>1</sub>	Bus B
5	7 GND Ground		Ground
4, 6	6, 9 1A, 2A Bus		Bus A
9	12	OE	Bus Switch Enable
10 14		V <sub>CC</sub>	Supply Voltage

#### **Truth Table**

S	OE	Function
Don't Care	HIGH Disconnect	
LOW	LOW	A=B <sub>1</sub>
HIGH	LOW	A=B <sub>2</sub>

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage		-0.5	4.6	V
Vs	DC Switch Voltage		-0.5	V <sub>CC</sub> + 0.05	V
V <sub>IN</sub>	DC Input Voltage <sup>(1)</sup>	-0.5	4.6	V	
I <sub>IK</sub>	DC Input Diode Current, V <sub>IN</sub> <0V	-50		mA	
I <sub>OUT</sub>	DC Output Sink Current	50		mA	
I <sub>CC</sub> / I <sub>GND</sub>	DC V <sub>CC</sub> / GND Current	±100		mA	
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C	
ESD Human Body Model, JESD2	Liveran Dady Madel JECD22 A444	All Pins	7000		V
	Human body woder, JESD22-A114	I/O to GND	7000		V

#### Note:

 The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Para	Min.	Max.	Unit	
V <sub>CC</sub>	Power Supply Operating	3.0	3.6	V	
V <sub>IN</sub>	Input Voltage		0	V <sub>CC</sub>	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
+ +	Input Dice and Fall Time	Switch Control Input <sup>(2)</sup>	0	5	ns/V
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time Switch I/O		0	DC	115/ V
T <sub>A</sub>	Operating Temperature, Free Air		-40	+85	°C

#### Note:

2. Unused control inputs must be held HIGH or LOW. They may not float.

## **DC Electrical Characteristics**

Typical values are at  $V_{CC}$  = 3.0V and  $T_A$  = 25°C.

Cumbal	Doromotor	Condition	V 00	T <sub>A</sub> =-40 to +85°C			l los!4
Symbol	Parameter	Condition	V <sub>cc</sub> (V)	Min.	Тур.	Max.	Unit
V <sub>IK</sub>	Clamp Diode Voltage	I <sub>IN</sub> = -18mA	3.0			-1.2	V
V <sub>IH</sub>	High-Level Input Voltage		3.0 to 3.6	2.0			V
V <sub>IL</sub>	Low-Level Input Voltage		3.0 to 3.6			0.8	V
I <sub>IN</sub>	Input Leakage Current	$0 \le V_{IN} \le 3.6V$	3.6			±1.0	μΑ
I <sub>OFF</sub>	Off-State Leakage Current	$0 \le A, B \le V_{CC}$	3.6			±1.0	μA
	0 : 1 0 0 : (3)	$V_{IN} = 0.8V, I_{ON} = 8mA$	3.0		5	7	0
R <sub>ON</sub>	Switch On Resistance <sup>(3)</sup>	$V_{IN} = 3.0V, I_{ON} = 8mA$	3.0		4.5	6.5	Ω
$\Delta R_{ON}$	Delta R <sub>ON</sub>	$V_{IN} = 0.8V, V_{IN} = 0V - 1.5V, I_{ON} = 8mA$	3.0		0.3		Ω
R <sub>FLAT(ON)</sub>	On Resistance Flatness <sup>(4)</sup>	I <sub>OUT</sub> = 8mA	3.0		1		Ω
I <sub>cc</sub>	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	3.6			1	μΑ

#### Notes:

- 3. Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the A or B pins.
- 4. Flatness is defines as the difference between the maximum and the minimum value on resistance over the specified range of conditions.

## **AC Electrical Characteristics**

Typical values are at  $V_{\text{CC}}$  = 3.3V and  $T_{\text{A}}$  = 25°C.

Symbol	Parameter	Condition	V <sub>cc</sub> (V)	Тур.	Max.	Unit	Figure	
t <sub>ON</sub>	Turn-On Time S-to-Bus B	V <sub>B</sub> = 0.8V	3.0 to 3.6	4.8	7.0	ns	Figure 9 Figure 10	
t <sub>OFF</sub>	Turn-Off Time S-to-Bus B	V <sub>B</sub> = 0.8V	3.0 to 3.6	2.2	4.0	ns	Figure 9 Figure 10	
t <sub>PD</sub>	Propagation Delay	C <sub>L</sub> = 10pF	3.0 to 3.6	0.25		ns	Figure 14	
O <sub>IRR</sub>	Non-Adjacent Off Isolation	$f = 250MHz,$ $R_L = 50\Omega$	3.0 to 3.6	-26		dB	Figure 11	
X <sub>TALK</sub>	Non-Adjacent Channel Crosstalk	$f = 250MHz,$ $R_L = 50\Omega$	3.0 to 3.6	-45		dB	Figure 12	
BW	2dP Pandwidth	$R_L = 50\Omega$ , $C_L = 0pF$	2 0 to 2 6	750		MHz	Figure 12	
DVV	-3dB Bandwidth	$R_L = 50\Omega, C_L = 5pF$	3.0 10 3.6	3.0 to 3.6	435		IVITZ	Figure 13

## **USB Related AC Electrical Characteristics**

Typical values are at  $V_{CC}$  = 3.3V and  $T_A$  = 25°C.

Symbol	Parameter	Condition	V <sub>cc</sub> (V)	Тур.	Unit	Figure
t <sub>SK(O)</sub>	Channel-to Channel Skew	C <sub>L</sub> = 10pF	3.0 to 3.6	0.051	ns	Figure 14 Figure 16
t <sub>SK(P)</sub>	Skew of Opposite Transition of the Same Output	C <sub>L</sub> = 10pF	3.0 to 3.6	0.020	ns	Figure 14 Figure 16
T <sub>J</sub>	Total Jitter	$R_L = 50\Omega, C_L = 10pF$ $t_R = t_F = 750ps$ at 480MPs	3.0 to 3.6	0.170	ns	

# Capacitance

Typical values are at  $V_{CC}$  = 3.3V and  $T_A$  = 25°C.

Symbol Parameter		Condition	Тур.	Unit
C <sub>IN</sub>	Control Pin Input Capacitance	$V_{CC} = 0V$	2.5	pF
C <sub>ON</sub>	A/B On Capacitance	V <sub>CC</sub> = 3.3V, /OE = 0V	12.0	pF
C <sub>OFF</sub>	Port B Off Capacitance	V <sub>CC</sub> and /OE = 3.3V	4.5	pF

## **Performance Characteristics**

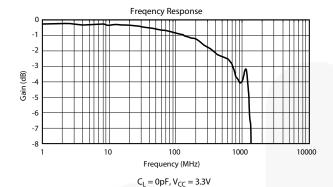


Figure 5. Gain vs. Frequency

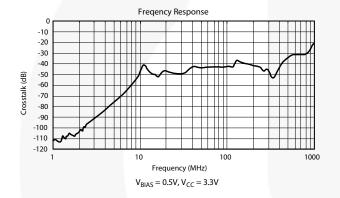


Figure 7. Crosstalk

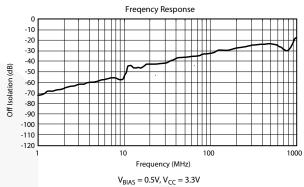


Figure 6. Off Isolation

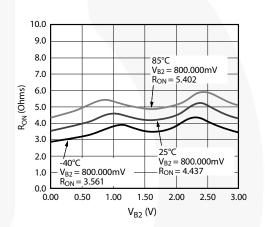
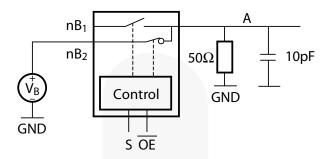


Figure 8. RoN

# **AC Loadings and Waveforms**



Notes: Input driven by  $50\Omega$  source terminated in  $50\Omega$ .  $C_L$  includes load and stray capacitance. Input PRR-1.0MHz,  $t_W$  = 500ns.

Figure 9. AC Test Circuit

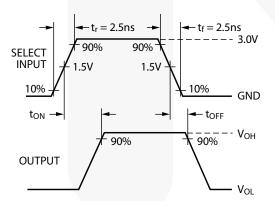


Figure 10. AC Waveforms

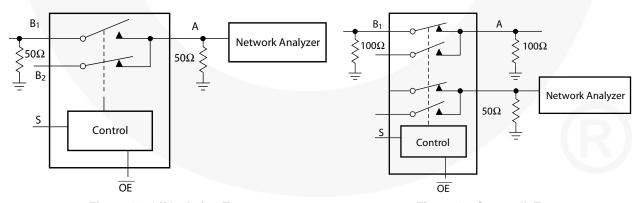


Figure 11. Off Isolation Test

Figure 12. Crosstalk Test

# AC Loadings and Waveforms

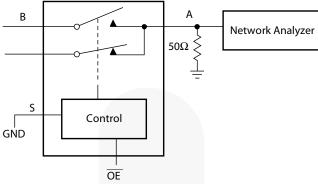


Figure 13. Bandwidth Test

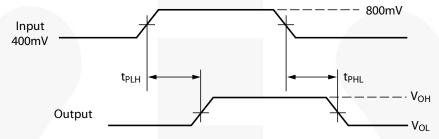


Figure 14. Propagation Delay

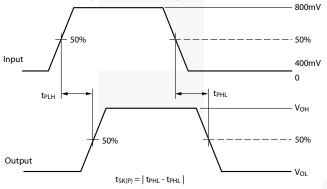


Figure 15. Pulse Skew t<sub>SP(P)</sub>

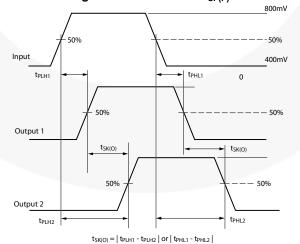


Figure 16. Output Skew t<sub>SK(O)</sub>

# **Physical Dimensions**

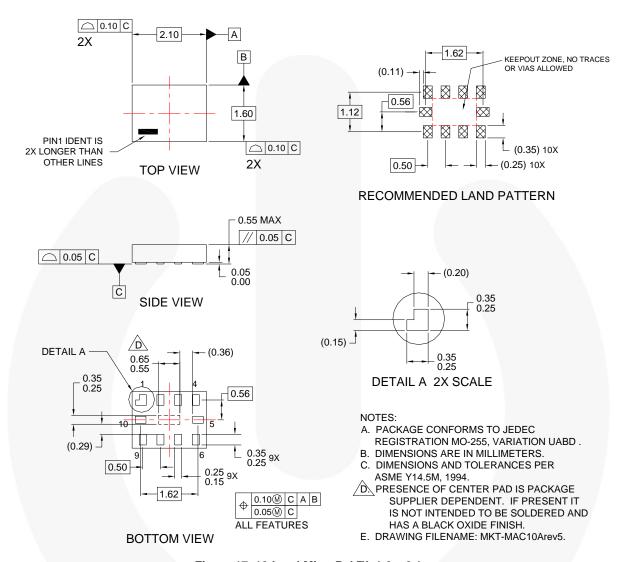


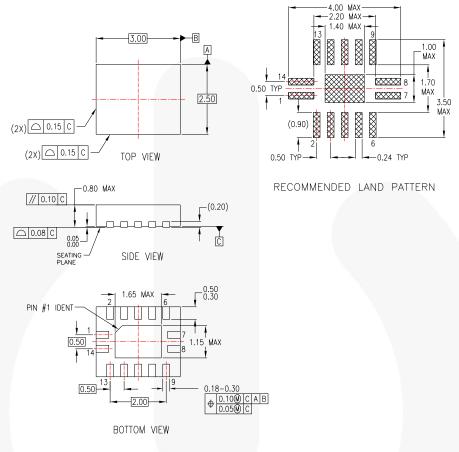
Figure 17. 10-Lead MicroPak™, 1.6 x 2.1mm

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <a href="http://www.fairchildsemi.com/packaging/">http://www.fairchildsemi.com/packaging/</a>

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/products/logic/pdf/micropak\_tr.pdf">http://www.fairchildsemi.com/products/logic/pdf/micropak\_tr.pdf</a>.

# **Physical Dimensions**



#### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AA
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP14ArevA

#### Figure 18. 14-Terminal Depopulation Quad Very-Thin Flat Pack No Lead (DQFN), JEDEC MO-241, 2.5 X 3.0mm

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <a href="http://www.fairchildsemi.com/packaging/">http://www.fairchildsemi.com/packaging/</a>

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/ms/MS/MS-522.pdf">http://www.fairchildsemi.com/ms/MS/MS-522.pdf</a>.

# **Physical Dimensions** Α 3.00±0.10 В ( 0.30 2.45 4.90 3.00±0.10 PIN#1 ID QUADRANT (0.381) TOP VIEW 0.85±0.10 1.10 MAX Ċ **END VIEW** ○ 0.10 C ALL LEAD TIPS 12° TOP & BOTTOM □.08 M A B C SIDE VIEW GAUGE PLANE R0.13 TYP SEATING NOTES: UNLESS OTHERWISE SPECIFIED 0.22 0.40 THIS PACKAGE CONFORMS TO JEDEC MO-187 VARIATION BA. ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS. DIMENSIONS AND TOLERANCES AS PER ASME (0.95) **DETAIL** A SCALE 20:1 /14.5-1994 LAND PATTERN AS PER IPC7351#SOP50P490X110-10AN F. FILE NAME: MKT-MUA10AREV3

Figure 19. 10-Lead Molded Small Outline Package (MSOP), JEDEC MO-187, 3.0mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/products/analog/pdf/msop10">http://www.fairchildsemi.com/products/analog/pdf/msop10</a> tr.pdf





#### **TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool® F-PEST FRFET® AccuPower™ Global Power Resource SM AX-CAP™\* GreenBridge™ BitSiC™ Build it Now™ Green FPS™ Green FPS™ e-Series™ CorePLUS™ CorePOWER™ Gmax™ GTO™ CROSSVOLT™ CTL™ IntelliMAX™ Current Transfer Logic™ ISOPLANAR™ Making Small Speakers Sound Louder DEUXPEED®

DEUXPEED® Making Small Speak
Dual Cool™ and Better™
EcoSPARK® MegaBuck™ MICROCOUPLER™
ESBC™ MicroFET™
MicroPak™ MicroPak™
MicroPak™

Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FAST®
FAST®
FastvCore™
FETBench™
FIsshWriter®\*

Miller Drive™
MotionMax™
Motion-SPM™
mWSaver™
OptoHiT™
OPTOLOGIC®
OPTOPLANAR®

PowerTrench® PowerXS™

Programmable Active Droop™

QFET<sup>®</sup>
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

Solutions for You SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™
EGENERAL®\*

The Power Franchise the power franchise TinyBoost™
TinyBuck™
TinyCalc™
TinyCalc™
TinyPower™
TinyPower™
TinyPower™
TinyPower™
TinyPower™
TinyPower™
TinyPuth™
TranSic™
TriFault Detect™
TRUECURRENT®\*

µSerDes™

SerDes UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS, THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

- Life support devices or systems are devices or systems which, (a)
  are intended for surgical implant into the body or (b) support or
  sustain life, and (c) whose failure to perform when properly used in
  accordance with instructions for use provided in the labeling, can be
  reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect curselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

#### Definition of Terms

Delinition of Terms		
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I61

<sup>\*</sup> Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdt/Patent-Marking.pdf">www.onsemi.com/site/pdt/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for USB Switch ICs category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

NLAS7213MUTBG FSA221UMX FSUSB31UMX FSA806UMX NLAS7222AMTR2G NL3S2223MUTBG TC7USB3212WBG(ELAH PI3USB31531ZLCEX PI3USB31532ZLCEX PI5USB31213XEAEX BD91N01NUX-E2 MP5030DGQH-Z NL3S22AHMUTAG NL3S22UHMUTAG FSA9280AUMX NLAS7242MUTBG HD3SS460RHRT TPS2549IRTERQ1 PI2USB4122ZHEX TS5USBC402IYFPT NS5S1153MUTAG FSUSB11MTCX FSUSB42MUX FT234XD-R PI3USB102GZLEX P6KE110A SMAJ200A SMAJ70CA SMAJ11A SMAJ140CA SMAJ14A SMAJ160CA SMAJ250A SMAJ51CA SMAJ5.0CA 30KP400CA 1SMB5.0AT3G MAX4717ETB+T MAX4989ETD+T MAX4717EBCT MAX4717EUB+ MAX4906ELB+T MAX4899EETE+ MAX4906EFELB+T MAX4907FELA+T MAX4907ELA+T MAX4983EEVB+T MAX4984EEVB+T MAX4899AEETE+T MAX14618ETA+T